

What is claimed is:

1. A computer cooling system comprising:

a housing made of a material having a good thermal conductance coefficient; formed as a shape of a hollow square; and having inner and housing housings, and a plurality of transverse partitions between the inner and outer housings; wherein, between two adjacent partitions is formed with a path penetrating through the housing, and front and rear ends of the paths alternately develop into openings (odd-number path each having an opening at a front end portion thereof, and each even-number path having an opening at a rear end portion thereof), such that the paths are distributed in communication, joined and located closely to one another at wall surfaces of the housing;

sealing panels joined at front and rear ends of the housing such that an interior of the housing becomes as a sealed environment; and having a water inlet and a water outlet that correspond with the paths of the housing; and a heat conducting plate made of a material having a good thermal conductance coefficient; having two pipes thereof connected with the water inlet and the water outlet of the sealing panels, and a pump; and can be directly attached to a CPU

or a hard disc of a computer; and according to the aforesaid structures, a cooling liquid is poured into the housing to have the cooling liquid fill up the paths, the pipes and an interior of the heat conducting plate; and the cooling liquid is circulated between the paths, the pipes and the heat conducting plate when the pump at the heat conducting plate is in operation.

2. The computer cooling system in accordance with claim 1, wherein the housing is devised into a shape having a U-shaped cross section; end portions of the housing are provided with an embedding strip and an embedding slot; two housings having U-shape cross sections are first joined with each other by embedding means, and then joined with the sealing panels into one body to form an integrated housing.